iC-LFL1402 256x1 LINEAR IMAGE SENSOR



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FEATURES APPLICATIONS Optical line sensors ♦ 256 active photo pixels of 56 µm at a gap and distortion free pitch of 63.5 µm (400 DPI) CCD substitute • Integrating L-V conversion followed by a sample & hold circuit High sensitivity and uniformity over wavelength ♦ High clockrates of up to 5 MHz Only 256 clocks required for readout Shutter function enables flexible integration times ♦ Glitch-free analogue output Push-pull output amplifier ♦ 5 V single supply operation Function equivalent to TSL1402 (serial mode) PACKAGES OBGA™ LFL1C





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DESCRIPTION

iC-LFL1402 is an integrating light-to-voltage converter with a single line of 256 pixels pitched at 63.5 μ m (center-to-center distance). Due to the monolithical integration there is no pixel-gap or pitch distortion what-soever. Each pixel consists of a 56.4 μ m x 200 μ m photodiode, an integration capacitor and a sample and hold circuit.

The integrated control logic makes operation very simple, with only a start and clock signal necessary. A third control input enables the integration period to be prematurely terminated at any time (electronic shutter). When the start signal is given the hold mode is activated for all pixels simultaneously with the next rising clock edge; starting with pixel 1 the hold voltages are switched in sequence to the push-pull output amplifier. The second clock pulse deletes all integration capacitors and the integration period starts again in the background during the output phase. A run is complete after 256 clock pulses.

iC-LFL1402 is suitable for high clock rates of up to 5 MHz.

PACKAGING INFORMATION OBGA[™] LFL1C

PIN CONFIGURATION OBGA™ LFL1C



PIN FUNCTIONS

No. Name Function

- 1 SI Start Integration Input
- 2 CLK Clock Input
- 3 AO Analogue Output
- 4 VCC +5 V Supply Voltage
- 5 RSET Connect to GND for internal bias
- 6 AGND Analogue Ground
- 7 GND Digital Ground
- 8 DIS Disable Integration Input

CHIP-LAYOUT		
iC-LFL1402 Chip size: 16.6 mm x 1.7 mm		
erctatries Image: Constraint of the constrai	AGND	TP RSET PIXEL 256 VDD VCC



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ABSOLUTE MAXIMUM RATINGS

Beyond these values damage may occur; device operation is not guaranteed.

Item	Symbol	Parameter	Conditions			Unit
No.				Min.	Max.	
G001	VDD	Digital Supply Voltage		-0.3	6	V
G002	VCC	Analogue Supply Voltage		-0.3	6	V
G003	V()	Voltage at SI, CLK, DIS, RSET, TP, AO		-0.3	VCC + 0.3	V
G004	I()	Current in RSET, TP, AO		-10	10	mA
G005	Vd()	ESD Susceptibility at all pins	HBM, 100 pF/1.5 kΩ		2	kV
G006	Tj	Operating Junction Temperature		-40	125	°C
G007	Ts	Storage Temperature Range	see package specification OBGA™ LFL1C			

THERMAL DATA	
Operating Conditions: VCC = VDD = 5 V ±10%	

ltem	Symbol	Parameter Conditions			Unit		
No.	-			Min.	Тур.	Max.	
T01	Та	Operating Ambient Temperature Range	see package specification				
			OBGA™ LFL1C				



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ELECTRICAL CHARACTERISTICS

Operating Conditions: VCC = VDD = 5 V ±10%, RSET = GND, Tj = -25110 °C unless otherwise noted							
ltem No.	Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Total I	Device	I			1	1	u
001	VDD	Digital Supply Voltage Range		4.5		5.5	V
002	VCC	Analogue Supply Voltage Range		4.5		5.5	V
003	I(VDD)	Supply Current in VDD	f(CLK) = 1 MHz f(CLK) = 5 MHz		0.39 1.85		mA mA
004	I(VCC)	Supply Current in VCC			11.5		mA
005	Vc()hi	Clamp Voltage hi at SI, CLK, DIS, TP, RSET	Vc()hi = V() — V(VCC); I() = 1 mA	0.3		1.8	V
006	Vc()lo	Clamp Voltage lo at SI, CLK, DIS, TP, RSET	Vc()hi = V() — V(AGND); I() = -1 mA	-1.5		0.3	V
007	Vc()hi	Clamp Voltage hi at AO	Vc()hi = V(AO) - V(VCC); I(AO) = 1 mA	0.3		1.5	V
008	Vc()lo	Clamp Voltage lo at AO, VCC, VDD, GND	Vc()lo = V() - V(AGND); l() = -1 mA	-1.5		-0.3	V
Photo	diode Array	-					
201	A()	Radiant Sensitive Area	200 µm x 56.40 µm per Pixel		0.01128		mm ²
202	$S(\lambda)$ max	Spectral Sensitivity	λ = 680 nm (see Fig. 1)		0.5		A/W
203	λ_{ar}	Spectral Application Range	$S(\lambda_{ar}) = 0.25 \times S(\lambda) max$ (see Fig. 1)	400		980	nm
Analo	gue Output	AO					
301	Vs()lo	Saturation Voltage lo	I() = 1 mA			0.5	V
302	Vs()hi	Saturation Voltage hi	Vs()hi = VCC - V(), I() = -1 mA			1	V
303	К	Sensitivity	λ = 680 nm, package OBGA™ LFL1C		2.88		V/pWs
304	V0()	Offset Voltage	integration time 1 ms, no illumination		400	800	mV
305	ΔV0()	Offset Voltage Deviation during integration mode	Δ V0() = V(AO)t1 - V(AO)t2, Δ t = t2 - t1 = 1 ms	-250		50	mV
306	ΔV()	Signal Deviation during hold mode	$\Delta V() = V(AO)t1 - V(AO)t2,$ $\Delta t = t2 - t1 = 1 \text{ ms}$	-150		150	mV
307	tp(CLK-AO)	Settling Time	Cl(AO) = 10 pF, CLK lo \rightarrow hi until V(AO) = 0.98 x V(VCC)			200	ns
Power	-On-Reset						
801	VCCon	Power-On Release by VCC				4.4	V
802	VCCoff	Power-Down Reset by VCC		1			V
803	VCChys	Hysteresis	VCChys = VCCon - VCCoff	0.4	1	2	V
Bias Current Adjust RSET							
901	Ibias()	Permissible External Bias Cur- rent		20		100	μA
902	Vref	Reference Voltage	I(RSET) = Ibias	2.5	3	3.5	V
Input Interface SI, CLK, DIS							
B01	Vt()hi	Threshold Voltage hi		1.4		1.8	V
B02	Vt()lo	Threshold Voltage Io		0.9		1.2	V
B03	Vt()hys	Hysteresis	Vt()hys = Vt()hi – Vt()lo	300		800	mV
B04	l()	Pull-Down Current		10	30	50	μA
B05	fclk	Permissible Clock Frequency				5	MHz



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OPTICAL CHARACTERISTICS: Diagrams





OPERATING REQUIREMENTS: Logic

Operating Conditions: VCC = VDD = 5 V ±10%, Tj = -25...110 °C input levels lo = 0...0.45 V, hi = 2.4 V...VCC, see Fig. 2 for reference levels

ltem	Symbol	Parameter	Conditions	Fig.			Unit
No.					Min.	Max.	
1001	tset	Setup Time: SI stable before CLK lo \rightarrow hi		3	50		ns
1002	thold	Hold Time: SI stable after CLK lo \rightarrow hi		3	50		ns



Figure 2: Reference levels



Figure 3: Timing diagram



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DESCRIPTION OF FUNCTIONS

Normal operation

Following an internal power-on reset the integration and hold capacitors are discharged and the sample and hold circuit is set to sample mode. A high signal at SI and a rising edge at CLK triggers a readout cycle and with it a new integration cycle.

In this process the hold capacitors of pixels 1 to 255 are switched to hold mode immediately (SNH = 1), with

pixel 256 (SNH256 = 1) following suit one clock pulse later. This special procedure allows all pixels to be read out with just 256 clock pulses. The integration capacitors are discharged by a one clock long reset signal (NRCI = 0) which occurs between the 2nd and 3rd falling edge of the readout clock pulse (cf. Figure 4). After the 255 pixels have been read out these are again set to sample mode (SNH = 0), likewise for pixel 256 one clock pulse later (SNH256 = 0).



Figure 4: Readout cycle and integration sequence

If prior to the 256th clock pulse a high signal occurs at SI the present readout is halted and immediately reinitiated with pixel 1. In this instance the hold capacitors retain their old value i.e. hold mode prevails (SNH/SNH256 = 0).



Figure 5: Restarting a readout cycle

With more than 256 clock pulses until the next SI signal, pixel 1 is output without entering hold mode; the out-

put voltage tracks the voltage of the pixel 1 integration capacitor.

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Figure 6: Clock pulse continued without giving a new integration start signal

Operation with the shutter function

Integration can be stopped at any time via pin DIS, i.e. the photodiodes are disconnected from their corresponding integration capacitor when DIS is high and the

current integration capacitor voltages are maintained. If this pin is open or switched to GND the pixel photocurrents are summed up by the integration capacitors until the next successive SI signal follows.



Figure 7: Defining the integration time via shutter input DIS

External bias current setting

In order to reduce the power consumption of the device an external reference current can be supplied to pin RSET which reduces the maximum readout frequency, however. To this end a resistor must be connected from VCC to RSET. If this pin is not used, it should be connected to GND.



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REVISION HISTORY

Rel.	Rel. Date*	Chapter	Modification	Page
A5	2017-08-11	ELECTRICAL CHARACTERISTICS	Operating conditions: Tj = -25110 °C	4
		OPERATING REQUIREMENTS	Operating conditions: Tj = -25110 °C	5

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ORDERING INFORMATION

Туре	Package	Order Designation
iC-LFL	OBGA™ LFL1C	iC-LFL OBGA LFL1C
iC-LFL	-	iC-LFL Chip

Please send your purchase orders to our order handling team:

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